

Result of tenders of RMB Sovereign Bonds held on June 20, 2019

The following is issued on behalf of the Hong Kong Monetary Authority:

Result of the tenders of RMB Sovereign Bonds held on June 20, 2019:

Tender Result

Tender Date : June 20, 2019

Bonds available for Tender : 2-year RMB Bonds

Issue Number : BCMKFB19023

Issue Date : June 24, 2019

Maturity Date : June 24, 2021 (or the closest coupon payment date)

Application Amount : RMB 11,243 million

Issue Amount : RMB 3,500 million

Average accepted Coupon Rate : 2.79 per cent

Highest accepted Coupon Rate
(Bonds' Coupon) : 2.95 per cent

Lowest accepted Coupon Rate : 2.50 per cent

Allocation Ratio : Approximately 1.51 per cent

Tender Result

Tender Date : June 20, 2019

Bonds available for Tender : 5-year RMB Bonds

Issue Number : BCMKFB19024

Issue Date : June 24, 2019

Maturity Date : June 24, 2024 (or the closest coupon payment date)

Application Amount : RMB 4,387 million

Issue Amount : RMB 1,000 million

Average accepted Coupon Rate : 2.92 per cent

Highest accepted Coupon Rate (Bonds' Coupon) : 3.03 per cent

Lowest accepted Coupon Rate : 2.70 per cent

Allocation Ratio : Approximately 42.96 per cent